

## 1300V 6A N-Channel Enhancement Mode Power MOSFET

### Description

The AKT6N130G is an N-Channel enhancement mode power MOSFET which using proprietary planar stripe and DMOS technology.

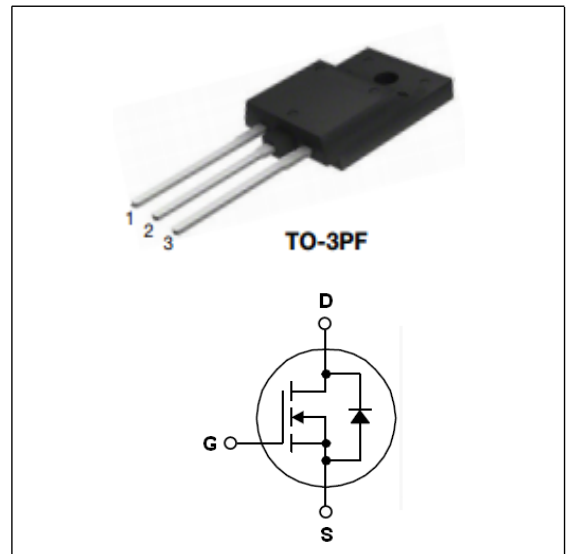
This device provide excellent switching performance for switched mode power supplies, active power factor correction and electronic lamp ballasts.

### Features

- Low on-Resistance:  $R_{DS(on)}=2.4\Omega(\text{typ.})$
- Special Process Technology for high ESD Capability
- 100% Avalanche Test
- Good Stability and Uniformity with High  $E_{AS}$

### Applications

- Switched Mode Power Supplies
- Active Power Factor Correction, Electronic Ballasts



### Absolute Maximum Ratings @ $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain to Source Voltage	1350	V
$V_{GSS}$	Gate to Source Voltage	$\pm 30$	V
$I_D$	Drain Current	$T_C=25^\circ\text{C}$	6
		$T_C=100^\circ\text{C}$	4
$I_{DM}$	Pulsed Drain Current (Note1)	18	A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	110
	Derate above $25^\circ\text{C}$		0.9
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	25	mJ
$T_J$	Operating Junction Temperature Range	-55~+150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55~+150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	1.1	$^\circ\text{C/W}$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	50	$^\circ\text{C/W}$

## Electrical Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=1mA$	1350	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	3	-	5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=3A$	-	2.4	4.0	$\Omega$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0V$	-	-	$\pm 200$	nA

## D-S Diode Characteristics and Maximum Rating @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Maximum Drain to Source Diode Forward Current		-	-	6	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS}=0V, I_S=6A$	-	0.84	0.95	V
$T_{rr}$	Reverse Recovery Time	$V_{GS}=0V, I_S=6A,$	-	560	-	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=-100A/\mu s$	-	3.8	-	nC

## Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=6A,$ $V_{DD}=650V,$ $R_G=20\Omega$ (Note 3)	-	21	-	ns
$t_r$	Rise Time		-	26	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	69	-	ns
$t_f$	Fall Time		-	25	-	ns
$C_{ies}$	Input Capacitance	$V_{GS}=0V, V_{DS}=25V,$ $f=1.0MHz$	-	2050	-	pF
$C_{oes}$	Output Capacitance		-	140	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	4.9	-	pF
$Q_g$	Total Gate Charge	$I_D=6A,$ $V_{DS}=1040V$ $V_{GS}=10V$ (Note 3)	-	47	-	nC
$Q_{gs}$	Gate to Source Charge		-	16	-	nC
$Q_{gd}$	Gate to Drain Charge		-	21	-	nC

### Note:

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $V_{DD}=100V, L=2mH, R_G=25\Omega, V_G=10V$ , stating  $T_J=25\text{ }^\circ\text{C}$
3. Essentially independent of operating temperature typical characteristics

**Typical Performance Characteristics**

Fig. 1. Typical on-Region Characteristics

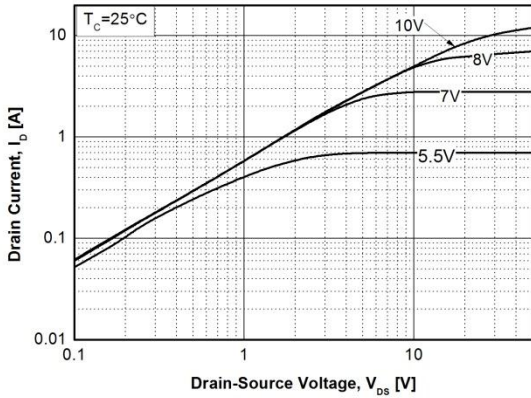


Fig. 2. Typical Transfer Characteristics

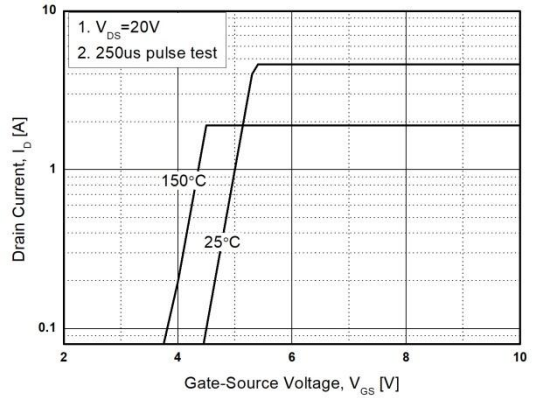


Fig. 3. Static on-Resistance vs.  $I_D$

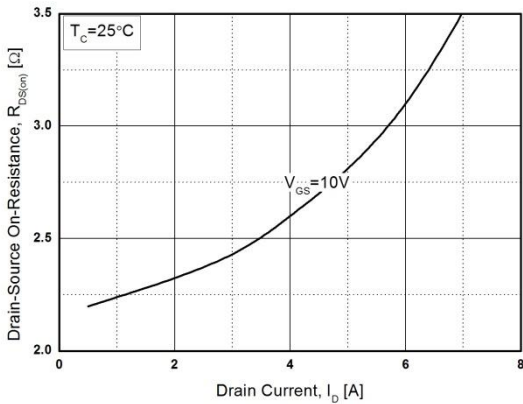


Fig. 4. Body Diode Forward Voltage vs.  $I_{DR}$

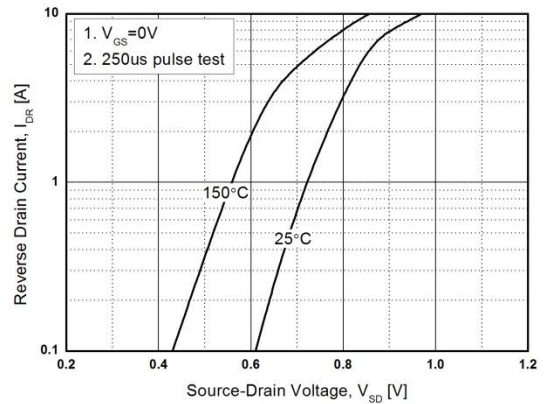


Fig. 5. Capacitance Characteristics

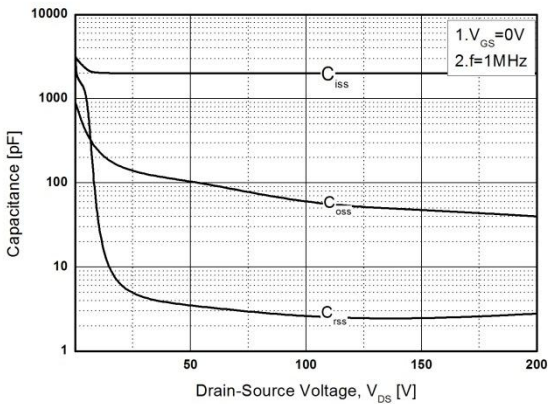
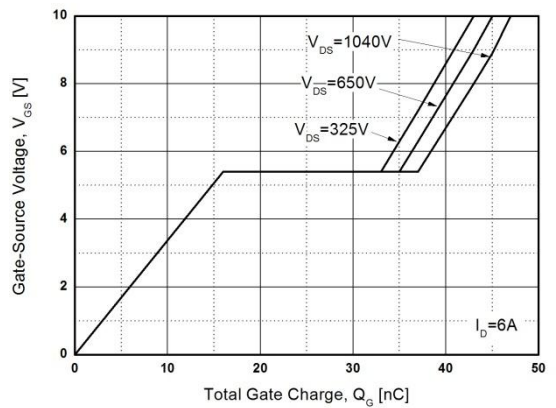


Fig. 6. Gate Charge Characteristics



**Typical Performance Characteristics**

Fig. 7. Breakdown Voltage vs. Temperature

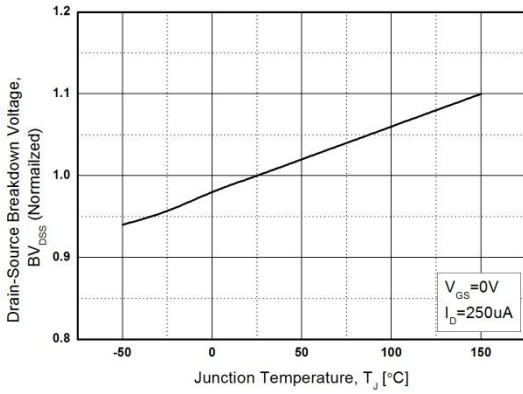


Fig. 8. Static on-Resistance vs. Temperature

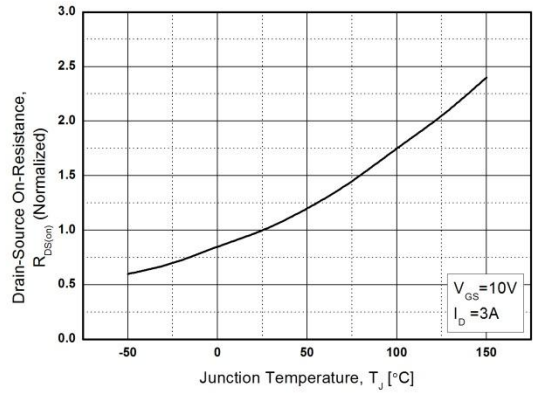


Fig. 9. Maximum Safe Operating Area

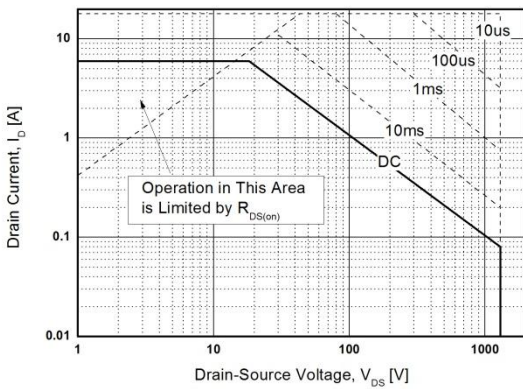


Fig. 10. Maximum Drain Current vs. Temperature

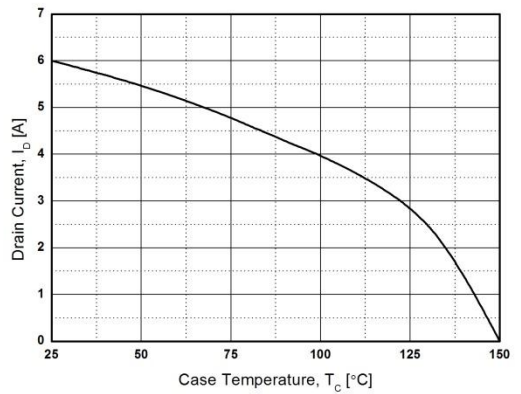
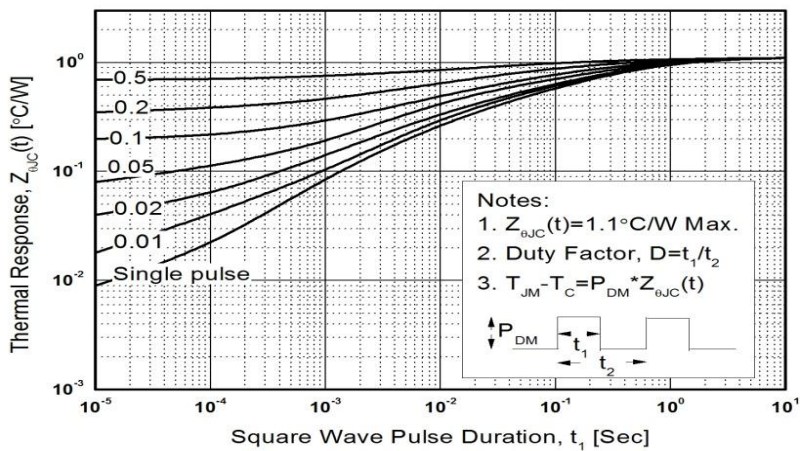


Fig. 11. Transient Thermal Response Curve



**Package Dimensions**

**TO-3PF**

(Dimensions in Millimeters)

